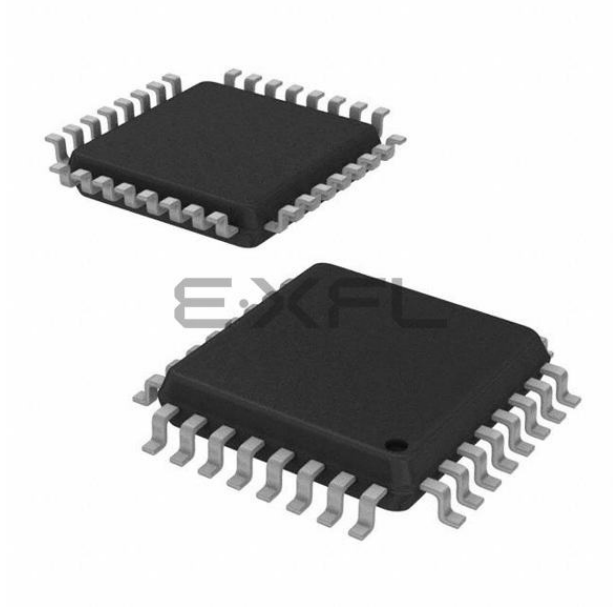

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	8051
Core Size	8-Bit
Speed	48MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	25
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 17x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	32-LQFP
Supplier Device Package	32-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f34b-gq

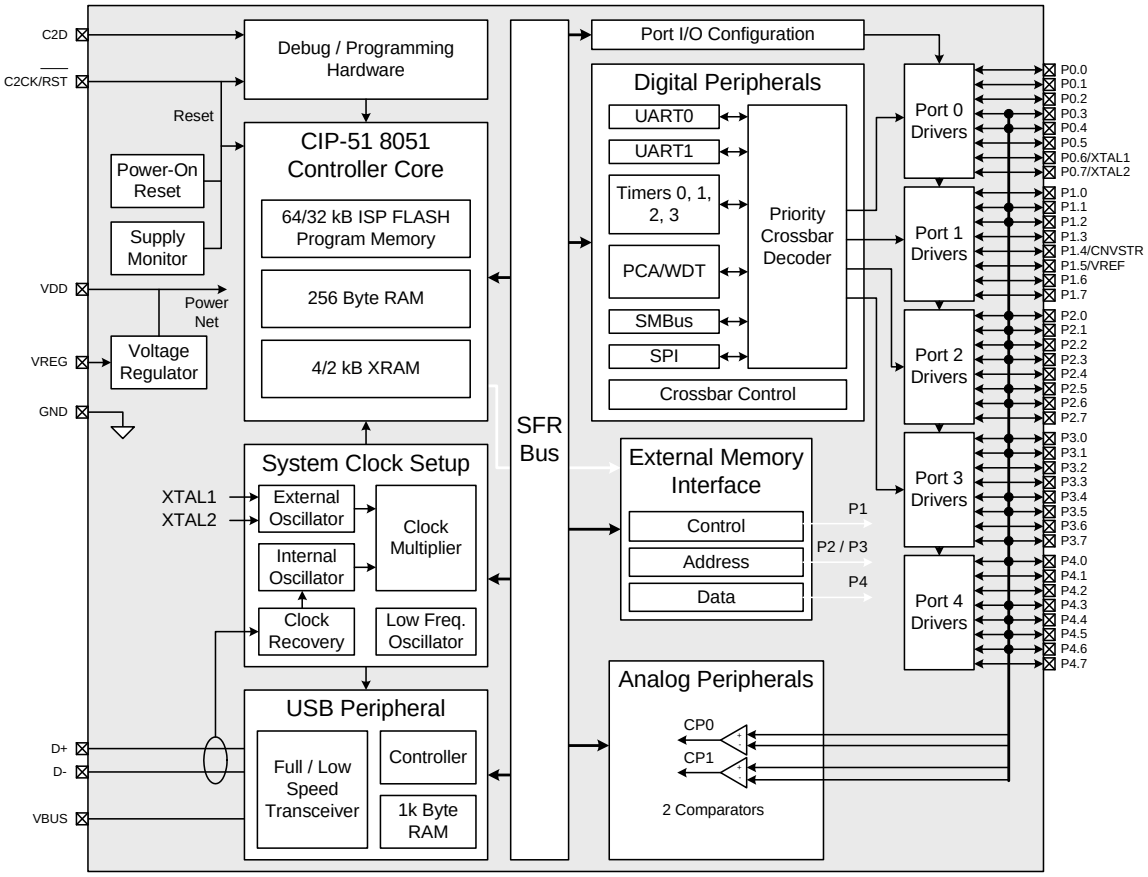

Figure 1.3. C8051F348/C Block Diagram

SFR Definition 5.2. AMX0N: AMUX0 Negative Channel Select

R	R	R	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	AMX0N4	AMX0N3	AMX0N2	AMX0N1	AMX0N0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xBA

Bits7–5: UNUSED. Read = 000b; Write = don't care.
Bits4–0: AMX0N4–0: AMUX0 Negative Input Selection.
Note that when GND is selected as the Negative Input, ADC0 operates in Single-ended mode. For all other Negative Input selections, ADC0 operates in Differential mode.

AMX0N4-0	ADC0 Negative Input (32-pin Package)	ADC0 Negative Input (48-pin Package)
00000	P1.0	P2.0
00001	P1.1	P2.1
00010	P1.2	P2.2
00011	P1.3	P2.3
00100	P1.4	P2.5
00101	P1.5	P2.6
00110	P1.6	P3.0
00111	P1.7	P3.1
01000	P2.0	P3.4
01001	P2.1	P3.5
01010	P2.2	P3.7
01011	P2.3	P4.0
01100	P2.4	P4.3
01101	P2.5	P4.4
01110	P2.6	P4.5
01111	P2.7	P4.6
10000	P3.0	RESERVED
10001	P0.0	P0.3
10010	P0.1	P0.4
10011	P0.4	P1.1
10100	P0.5	P1.2
10101 - 11101	RESERVED	RESERVED
11110	VREF	VREF
11111	GND (Single-Ended Mode)	GND (Single-Ended Mode)

SFR Definition 6.1. REF0CN: Reference Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	REFSL	TEMPE	BIASE	REFBE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xD1

Bits7–3: UNUSED. Read = 00000b; Write = don't care.
Bit3: REFSL: Voltage Reference Select.
This bit selects the source for the internal voltage reference.
0: VREF pin used as voltage reference.
1: V_{DD} used as voltage reference.
Bit2: TEMPE: Temperature Sensor Enable Bit.
0: Internal Temperature Sensor off.
1: Internal Temperature Sensor on.
Bit1: BIASE: Internal Analog Bias Generator Enable Bit.
0: Internal Bias Generator off.
1: Internal Bias Generator on.
Bit0: REFBE: Internal Reference Buffer Enable Bit.
0: Internal Reference Buffer disabled.
1: Internal Reference Buffer enabled. Internal voltage reference driven on the VREF pin.

Table 6.1. Voltage Reference Electrical Characteristics

V_{DD} = 3.0 V; –40 to +85 °C Unless Otherwise Specified

Parameter	Conditions	Min	Typ	Max	Units
Internal Reference (REFBE = 1)					
Output Voltage	25 °C ambient	2.38	2.44	2.50	V
VREF Short-Circuit Current				10	mA
VREF Temperature Coefficient			15		ppm/°C
Load Regulation	Load = 0 to 200 µA to GND		1.5		ppm/µA
VREF Turn-on Time 1	4.7 µF tantalum, 0.1 µF ceramic bypass		2		ms
VREF Turn-on Time 2	0.1 µF ceramic bypass		20		µs
VREF Turn-on Time 3	no bypass cap		10		µs
Power Supply Rejection			140		ppm/V
External Reference (REFBE = 0)					
Input Voltage Range		0		V_{DD}	V
Input Current	Sample Rate = 200 ksps; VREF = 3.0 V		12		µA
Bias Generators					
ADC Bias Generator	BIASE = '1'		100		µA
Reference Bias Generator			40		µA

8. Voltage Regulator (REG0)

C8051F34x devices include a voltage regulator (REG0). When enabled, the REG0 output appears on the V_{DD} pin and can be used to power external devices. REG0 can be enabled/disabled by software using bit REGEN in register REG0CN. See Table 8.1 for REG0 electrical characteristics.

Note that the VBUS signal must be connected to the VBUS pin when using the device in a USB network. The VBUS signal should only be connected to the REGIN pin when operating the device as a bus-powered function. REG0 configuration options are shown in Figure 8.1–Figure 8.4.

8.1. Regulator Mode Selection

REG0 offers a low power mode intended for use when the device is in suspend mode. In this low power mode, the REG0 output remains as specified; however the REG0 dynamic performance (response time) is degraded. See Table 8.1 for normal and low power mode supply current specifications. The REG0 mode selection is controlled via the REGMOD bit in register REG0CN.

8.2. VBUS Detection

When the USB Function Controller is used (see section **Section “16. Universal Serial Bus Controller (USB0)” on page 159**), the VBUS signal should be connected to the VBUS pin. The VBSTAT bit (register REG0CN) indicates the current logic level of the VBUS signal. If enabled, a VBUS interrupt will be generated when the VBUS signal matches the polarity selected by the VBPOL bit in register REG0CN. The VBUS interrupt is level-sensitive, and has no associated interrupt pending flag. The VBUS interrupt will be active as long as the VBUS signal matches the polarity selected by VBPOL. See Table 8.1 for VBUS input parameters.

Important Note: When USB is selected as a reset source, a system reset will be generated when the VBUS signal matches the polarity selected by the VBPOL bit. See **Section “11. Reset Sources” on page 100** for details on selecting USB as a reset source

Table 8.1. Voltage Regulator Electrical Specifications

–40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
Input Voltage Range[1]		2.7		5.25	V
Output Voltage (V_{DD})[2]	Output Current = 1 to 100 mA	3.0	3.3	3.6	V
Output Current[2]				100	mA
VBUS Detection Input Low Voltage				1.0	V
VBUS Detection Input High Voltage		3.0			V
Bias Current	Normal Mode (REGMOD = ‘0’) Low Power Mode (REGMOD = ‘1’)		65 35	111 61	µA
Dropout Voltage (V_{DO})[3]			1		mV/mA

Notes:
1. Input range specified for regulation. When an external regulator is used, should be tied to V_{DD}.
2. Output current is total regulator output, including any current required by the C8051F34x.
3. The minimum input voltage is 2.70 V or VDD + V_{DO} (max load), whichever is greater.

11.3. External Reset

The external $\overline{\text{RST}}$ pin provides a means for external circuitry to force the device into a reset state. Asserting an active-low signal on the $\overline{\text{RST}}$ pin generates a reset; an external pull-up and/or decoupling of the $\overline{\text{RST}}$ pin may be necessary to avoid erroneous noise-induced resets. See Table 11.1 for complete $\overline{\text{RST}}$ pin specifications. The PINRSF flag (RSTSRC.0) is set on exit from an external reset.

11.4. Missing Clock Detector Reset

The Missing Clock Detector (MCD) is a one-shot circuit that is triggered by the system clock. If more than 100 µs pass between rising edges on the system clock, the one-shot will time out and generate a reset. After a MCD reset, the MCDRSF flag (RSTSRC.2) will read ‘1’, signifying the MCD as the reset source; otherwise, this bit reads ‘0’. Writing a ‘1’ to the MCDRSF bit enables the Missing Clock Detector; writing a ‘0’ disables it. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.5. Comparator0 Reset

Comparator0 can be configured as a reset source by writing a ‘1’ to the C0RSEF flag (RSTSRC.5). Comparator0 should be enabled and allowed to settle prior to writing to C0RSEF to prevent any turn-on chatter on the output from generating an unwanted reset. The Comparator0 reset is active-low: if the non-inverting input voltage (on CP0+) is less than the inverting input voltage (on CP0-), a system reset is generated. After a Comparator0 reset, the C0RSEF flag (RSTSRC.5) will read ‘1’ signifying Comparator0 as the reset source; otherwise, this bit reads ‘0’. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.6. PCA Watchdog Timer Reset

The programmable Watchdog Timer (WDT) function of the Programmable Counter Array (PCA) can be used to prevent software from running out of control during a system malfunction. The PCA WDT function can be enabled or disabled by software as described in **Section “22.3. Watchdog Timer Mode” on page 264**; the WDT is enabled and clocked by SYSCLK / 12 following any reset. If a system malfunction prevents user software from updating the WDT, a reset is generated and the WDTRSF bit (RSTSRC.5) is set to ‘1’. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

11.7. Flash Error Reset

If a Flash read/write/erase or program read targets an illegal address, a system reset is generated. This may occur due to any of the following:

- A Flash write or erase is attempted above user code space. This occurs when PSWE is set to “1”, and a MOVX write operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read is attempted above user code space. This occurs when a MOVC operation is attempted above address 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Program read is attempted above user code space. This occurs when user code attempts to branch to an address above 0x7FFF (32 kB Flash devices) or 0xFBFF (64 kB Flash devices).
- A Flash read, write or erase attempt is restricted due to a Flash security setting (see **Section “12.3. Security Options” on page 109**).
- A Flash Write or Erase is attempted when the V_{DD} monitor is not enabled.

The FERROR bit (RSTSRC.6) is set following a Flash error reset. The state of the $\overline{\text{RST}}$ pin is unaffected by this reset.

SFR Definition 11.2. RSTSRC: Reset Source

R/W	R	R/W	R/W	R	R/W	R/W	R	Reset Value
USBRSF	FERROR	C0RSEF	SWRSF	WDTRSF	MCDRSF	PORSF	PINRSF	Variable
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xEF

Bit7: USBRSF: USB Reset Flag
0: **Read:** Last reset was not a USB reset; **Write:** USB resets disabled.
1: **Read:** Last reset was a USB reset; **Write:** USB resets enabled.

Bit6: FERROR: Flash Error Indicator.
0: Source of last reset was not a Flash read/write/erase error.
1: Source of last reset was a Flash read/write/erase error.

Bit5: C0RSEF: Comparator0 Reset Enable and Flag.
0: **Read:** Source of last reset was not Comparator0; **Write:** Comparator0 is not a reset source.
1: **Read:** Source of last reset was Comparator0; **Write:** Comparator0 is a reset source (active-low).

Bit4: SWRSF: Software Reset Force and Flag.
0: **Read:** Source of last reset was not a write to the SWRSF bit; **Write:** No Effect.
1: **Read:** Source of last was a write to the SWRSF bit; **Write:** Forces a system reset.

Bit3: WDTRSF: Watchdog Timer Reset Flag.
0: Source of last reset was not a WDT timeout.
1: Source of last reset was a WDT timeout.

Bit2: MCDRSF: Missing Clock Detector Flag.
0: **Read:** Source of last reset was not a Missing Clock Detector timeout; **Write:** Missing Clock Detector disabled.
1: **Read:** Source of last reset was a Missing Clock Detector timeout; **Write:** Missing Clock Detector enabled; triggers a reset if a missing clock condition is detected.

Bit1: PORSF: Power-On / V_{DD} Monitor Reset Flag.
This bit is set anytime a power-on reset occurs. Writing this bit selects/deselects the V_{DD} monitor as a reset source. **Note: writing '1' to this bit before the V_{DD} monitor is enabled and stabilized can cause a system reset.** See register VDM0CN (SFR Definition 11.1).
0: **Read:** Last reset was not a power-on or V_{DD} monitor reset; **Write:** V_{DD} monitor is not a reset source.
1: **Read:** Last reset was a power-on or V_{DD} monitor reset; all other reset flags indeterminate; **Write:** V_{DD} monitor is a reset source.

Bit0: PINRSF: HW Pin Reset Flag.
0: Source of last reset was not $\overline{\text{RST}}$ pin.
1: Source of last reset was $\overline{\text{RST}}$ pin.

Note: For bits that act as both reset source enables (on a write) and reset indicator flags (on a read), read-modify-write instructions read and modify the source enable only. This applies to bits: USBRSF, C0RSEF, SWRSF, MCDRSF, PORSF.

13. External Data Memory Interface and On-Chip XRAM

4k Bytes (C8051F340/2/4/6/A/C/D) or 2k Bytes (C8051F341/3/5/7/8/9/B) of RAM are included on-chip, and mapped into the external data memory space (XRAM). The 1k Bytes of USB FIFO space can also be mapped into XRAM address space for additional general-purpose data storage. Additionally, an External Memory Interface (EMIF) is available on the C8051F340/1/4/5/8/C devices, which can be used to access off-chip data memories and memory-mapped devices connected to the GPIO ports. The external memory space may be accessed using the external move instruction (MOVX) and the data pointer (DPTR), or using the MOVX indirect addressing mode using R0 or R1. If the MOVX instruction is used with an 8-bit address operand (such as @R1), then the high byte of the 16-bit address is provided by the External Memory Interface Control Register (EMI0CN, shown in SFR Definition 13.1). Note: the MOVX instruction can also be used for writing to the FLASH memory. See **Section “12. Flash Memory” on page 107** for details. The MOVX instruction accesses XRAM by default.

13.1. Accessing XRAM

The XRAM memory space is accessed using the MOVX instruction. The MOVX instruction has two forms, both of which use an indirect addressing method. The first method uses the Data Pointer, DPTR, a 16-bit register which contains the effective address of the XRAM location to be read from or written to. The second method uses R0 or R1 in combination with the EMI0CN register to generate the effective XRAM address. Examples of both of these methods are given below.

13.1.1. 16-Bit MOVX Example

The 16-bit form of the MOVX instruction accesses the memory location pointed to by the contents of the DPTR register. The following series of instructions reads the value of the byte at address 0x1234 into the accumulator A:

```
MOV    DPTR, #1234h        ; load DPTR with 16-bit address to read (0x1234)
MOVX   A, @DPTR            ; load contents of 0x1234 into accumulator A
```

The above example uses the 16-bit immediate MOV instruction to set the contents of DPTR. Alternately, the DPTR can be accessed through the SFR registers DPH, which contains the upper 8-bits of DPTR, and DPL, which contains the lower 8-bits of DPTR.

13.1.2. 8-Bit MOVX Example

The 8-bit form of the MOVX instruction uses the contents of the EMI0CN SFR to determine the upper 8-bits of the effective address to be accessed and the contents of R0 or R1 to determine the lower 8-bits of the effective address to be accessed. The following series of instructions read the contents of the byte at address 0x1234 into the accumulator A.

```
MOV    EMI0CN, #12h        ; load high byte of address into EMI0CN
MOV    R0, #34h            ; load low byte of address into R0 (or R1)
MOVX   a, @R0              ; load contents of 0x1234 into accumulator A
```

13.2. Accessing USB FIFO Space

The C8051F34x devices include 1k of RAM which functions as USB FIFO space. Figure 13.1 shows an expanded view of the FIFO space and user XRAM. FIFO space is normally accessed via USB FIFO registers; see **Section "16.5. FIFO Management" on page 167** for more information on accessing these FIFOs. The MOVX instruction should not be used to load or modify USB data in the FIFO space.

Unused areas of the USB FIFO space may be used as general purpose XRAM if necessary. The FIFO block operates on the USB clock domain; thus the USB clock must be active when accessing FIFO space. Note that the number of SYSCLK cycles required by the MOVX instruction is increased when accessing USB FIFO space.

To access the FIFO RAM directly using MOVX instructions, the following conditions must be met: (1) the USBFAE bit in register EMI0CF must be set to '1', and (2) the USB clock must be greater than or equal to twice the SYSCLK (USBCLK $\geq$ 2 x SYSCLK). When this bit is set, the USB FIFO space is mapped into XRAM space at addresses 0x0400 to 0x07FF. The normal XRAM (on-chip or external) at the same addresses cannot be accessed when the USBFAE bit is set to '1'.

Important Note: The USB clock must be active when accessing FIFO space.

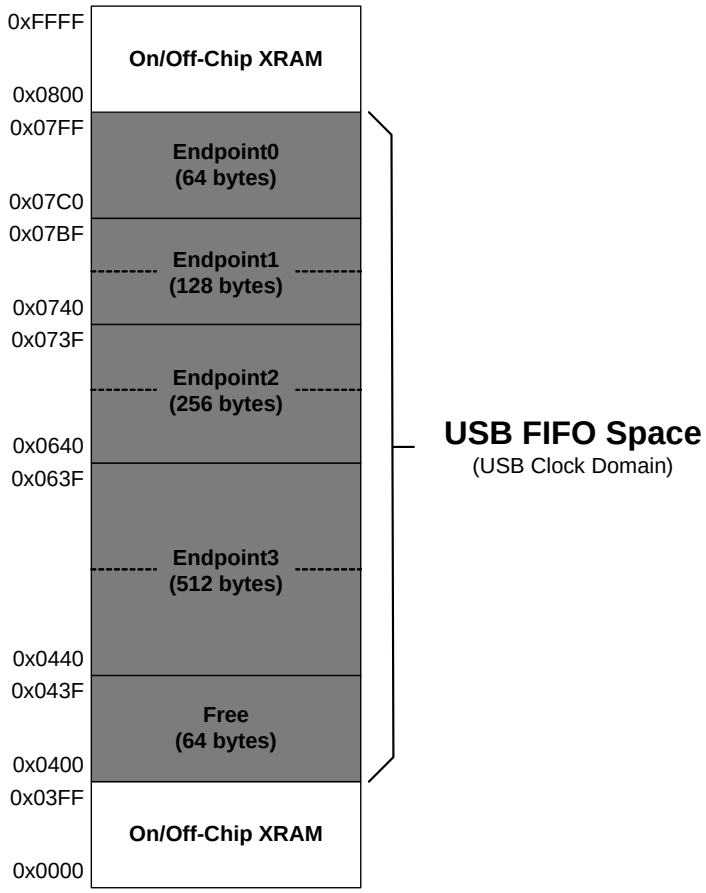

Figure 13.1. USB FIFO Space and XRAM Memory Map with USBFAE set to '1'

13.7.1.3.8-bit MOVX with Bank Select: EMI0CF[4:2] = ‘110’.

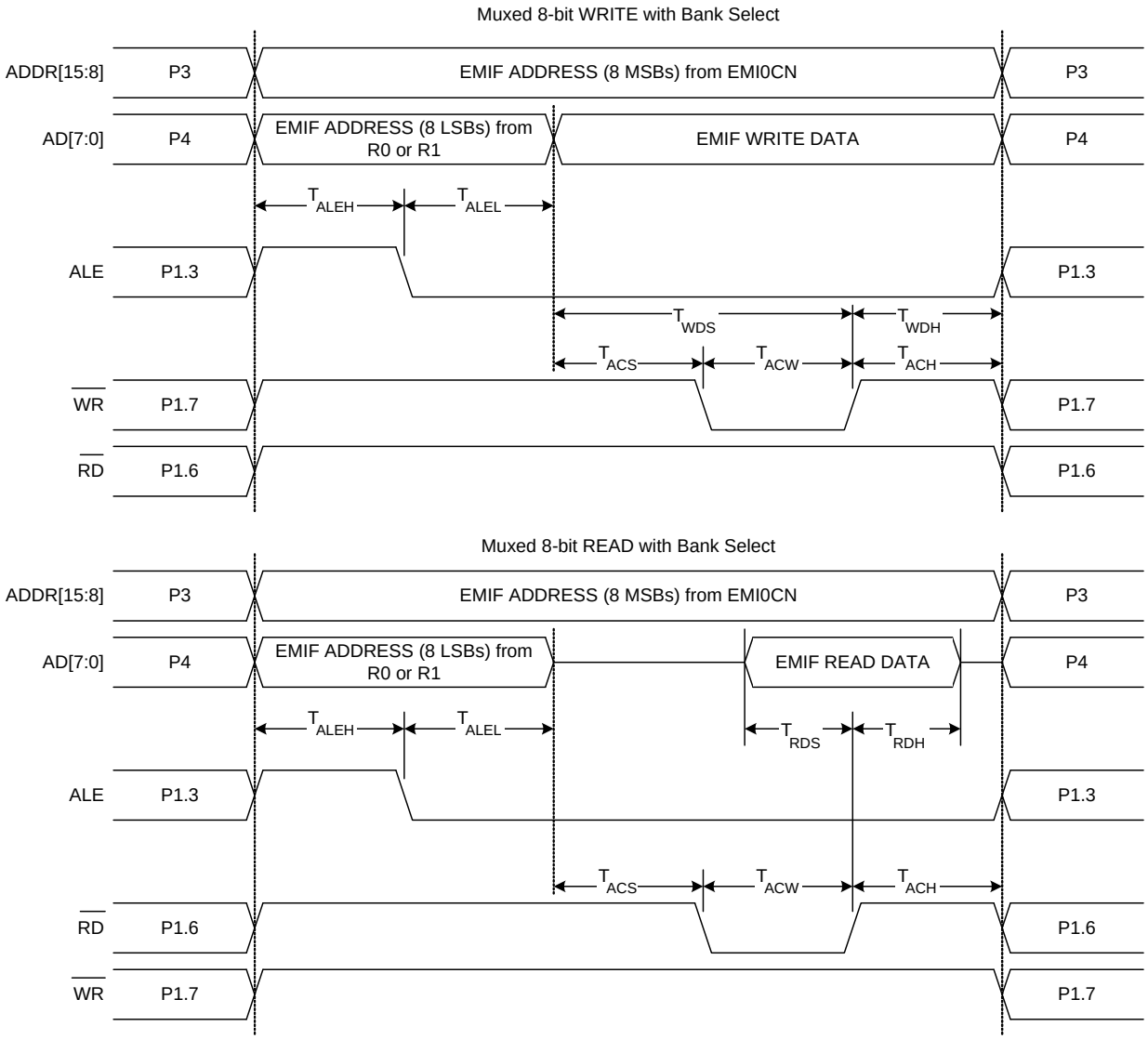

Figure 13.7. Non-multiplexed 8-bit MOVX with Bank Select Timing

14.1. Programmable Internal High-Frequency (H-F) Oscillator

All C8051F34x devices include a programmable internal oscillator that defaults as the system clock after a system reset. The internal oscillator period can be programmed via the OSCICL register shown in SFR Definition 14.2. The OSCICL register is factory calibrated to obtain a 12 MHz internal oscillator frequency. Electrical specifications for the precision internal oscillator are given in Table 14.1 on page 141. Note that the system clock may be derived from the programmed internal oscillator divided by 1, 2, 4, or 8, as defined by the IFCN bits in register OSCICN. The divide value defaults to 8 following a reset.

14.1.1. Internal H-F Oscillator Suspend Mode

The internal high-frequency oscillator may be placed in Suspend mode by writing '1' to the SUSPEND bit in register OSCICN. In Suspend mode, the internal H-F oscillator is stopped until a non-idle USB event is detected (**Section 16**) or VBUS matches the polarity selected by the VBPOL bit in register REG0CN (**Section 8.2**). Note that the USB transceiver can still detect USB events when it is disabled.

SFR Definition 14.1. OSCICN: Internal H-F Oscillator Control

R/W	R	R/W	R	R/W	R/W	R/W	R/W	Reset Value
IOSCEN	IFRDY	SUSPEND	-	-	-	IFCN1	IFCN0	10000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xB2

Bit7: IOSCEN: Internal H-F Oscillator Enable Bit.
0: Internal H-F Oscillator Disabled.
1: Internal H-F Oscillator Enabled.

Bit6: IFRDY: Internal H-F Oscillator Frequency Ready Flag.
0: Internal H-F Oscillator is not running at programmed frequency.
1: Internal H-F Oscillator is running at programmed frequency.

Bit5: SUSPEND: Force Suspend
Writing a '1' to this bit will force the internal H-F oscillator to be stopped. The oscillator will be re-started on the next non-idle USB event (i.e., RESUME signaling) or VBUS interrupt event (see SFR Definition 8.1).

Bits4–2: UNUSED. Read = 000b, Write = don't care.

Bits1–0: IFCN1–0: Internal H-F Oscillator Frequency Control.
00: SYSCLK derived from Internal H-F Oscillator divided by 8.
01: SYSCLK derived from Internal H-F Oscillator divided by 4.
10: SYSCLK derived from Internal H-F Oscillator divided by 2.
11: SYSCLK derived from Internal H-F Oscillator divided by 1.

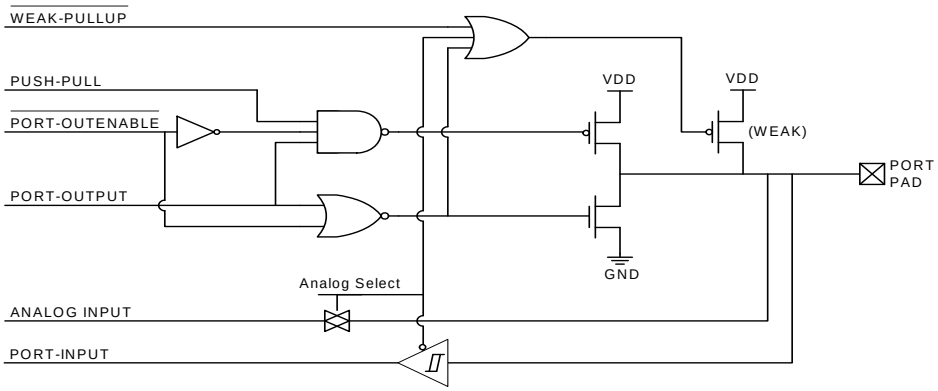

Figure 15.2. Port I/O Cell Block Diagram

SFR Definition 15.11. P1SKIP: Port1 Skip

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xD5

Bits7–0: P1SKIP[7:0]: Port1 Crossbar Skip Enable Bits.
These bits select Port pins to be skipped by the Crossbar Decoder. Port pins used as analog inputs (for ADC or Comparator) or used as special functions (VREF input, external oscillator circuit, CNVSTR input) should be skipped by the Crossbar.
0: Corresponding P1.n pin is not skipped by the Crossbar.
1: Corresponding P1.n pin is skipped by the Crossbar.

SFR Definition 15.12. P2: Port2 Latch

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xA0

Bits7–0: P2.[7:0]
Write - Output appears on I/O pins per Crossbar Registers (when XBARE = ‘1’).
0: Logic Low Output.
1: Logic High Output (high impedance if corresponding P2MDOUT.n bit = 0).
Read - Always reads ‘0’ if selected as analog input in register P2MDIN. Directly reads Port pin when configured as digital input.
0: P2.n pin is logic low.
1: P2.n pin is logic high.

SFR Definition 15.13. P2MDIN: Port2 Input Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xF3

Bits7-0: Analog Input Configuration Bits for P2.7-P2.0 (respectively).
Port pins configured as analog inputs have their weak pull-up, digital driver, and digital receiver disabled.
0: Corresponding P2.n pin is configured as an analog input.
1: Corresponding P2.n pin is not configured as an analog input.

17.5.2. Master Receiver Mode

Serial data is received on SDA while the serial clock is output on SCL. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 1 (READ). Serial data is then received from the slave on SDA while the SMBus outputs the serial clock. The slave transmits one or more bytes of serial data. After each byte is received, ACKRQ is set to ‘1’ and an interrupt is generated. Software must write the ACK bit (SMB0CN.1) to define the outgoing acknowledge value (Note: writing a ‘1’ to the ACK bit generates an ACK; writing a ‘0’ generates a NACK). Software should write a ‘0’ to the ACK bit after the last byte is received, to transmit a NACK. The interface exits Master Receiver Mode after the STO bit is set and a STOP is generated. Note that the interface will switch to Master Transmitter Mode if SMB0DAT is written while an active Master Receiver. Figure 17.6 shows a typical Master Receiver sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur **before** the ACK cycle in this mode.

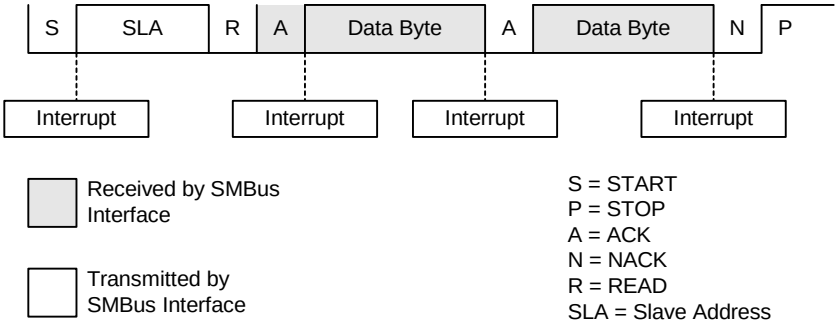

Figure 17.6. Typical Master Receiver Sequence

SFR Definition 19.3. SBUF1: UART1 Data Buffer

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xD3

Bits7–0: SBUF1[7:0]: Serial Data Buffer Bits 7–0 (MSB-LSB)
This SFR is used to both send data from the UART and to read received data from the UART1 receive FIFO.
Write: Writing a byte to SBUF1 initiates the transmission. When data is written to SBUF1, it first goes to the Transmit Holding Register, where it is held for serial transmission. When the transmit shift register is available, data is transferred into the shift register, and SBUF1 may be written again.
Read: Reading SBUF1 retrieves data from the receive FIFO. When read, the oldest byte in the receive FIFO is returned, and removed from the FIFO. Up to three bytes may be held in the FIFO. If there are additional bytes available in the FIFO, the RI1 bit will remain at logic '1', even after being cleared by software.

SFR Definition 19.4. SBCON1: UART1 Baud Rate Generator Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
Reserved	SB1RUN	Reserved	Reserved	Reserved	Reserved	SB1PS1	SB1PS0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

SFR Address: 0xAC

Bit7: RESERVED: Read = 0b; Must write 0b.
Bit6: SB1RUN: Baud Rate Generator Enable.
0: Baud Rate Generator is disabled. UART1 will not function.
1: Baud Rate Generator is enabled.
Bits5–2: RESERVED: Read = 0000b; Must write 0000b.
Bits1–0: SB1PS[1:0]: Baud Rate Prescaler Select.
00: Prescaler = 12
01: Prescaler = 4
10: Prescaler = 48
11: Prescaler = 1

SFR Definition 21.2. TMOD: Timer Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
GATE1	C/T1	T1M1	T1M0	GATE0	C/T0	T0M1	T0M0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x89

Bit7: GATE1: Timer 1 Gate Control.
0: Timer 1 enabled when TR1 = 1 irrespective of $\overline{INT1}$ logic level.
1: Timer 1 enabled only when TR1 = 1 AND $\overline{INT1}$ is active as defined by bit IN1PL in register INT01CF (see SFR Definition 9.13).

Bit6: C/T1: Counter/Timer 1 Select.
0: Timer Function: Timer 1 incremented by clock defined by T1M bit (CKCON.3).
1: Counter Function: Timer 1 incremented by high-to-low transitions on external input pin (T1).

Bits5–4: T1M1–T1M0: Timer 1 Mode Select.
These bits select the Timer 1 operation mode.

T1M1	T1M0	Mode
0	0	Mode 0: 13-bit counter/timer
0	1	Mode 1: 16-bit counter/timer
1	0	Mode 2: 8-bit counter/timer with auto-reload
1	1	Mode 3: Timer 1 inactive

Bit3: GATE0: Timer 0 Gate Control.
0: Timer 0 enabled when TR0 = 1 irrespective of $\overline{INT0}$ logic level.
1: Timer 0 enabled only when TR0 = 1 AND $\overline{INT0}$ is active as defined by bit IN0PL in register INT01CF (see SFR Definition 9.13).

Bit2: C/T0: Counter/Timer Select.
0: Timer Function: Timer 0 incremented by clock defined by T0M bit (CKCON.2).
1: Counter Function: Timer 0 incremented by high-to-low transitions on external input pin (T0).

Bits1–0: T0M1–T0M0: Timer 0 Mode Select.
These bits select the Timer 0 operation mode.

T0M1	T0M0	Mode
0	0	Mode 0: 13-bit counter/timer
0	1	Mode 1: 16-bit counter/timer
1	0	Mode 2: 8-bit counter/timer with auto-reload
1	1	Mode 3: Two 8-bit counter/timers

21.2.2. 8-bit Timers with Auto-Reload

When T2SPLIT = ‘1’ and T2CE = ‘0’, Timer 2 operates as two 8-bit timers (TMR2H and TMR2L). Both 8-bit timers operate in auto-reload mode as shown in Figure 21.5. TMR2RLL holds the reload value for TMR2L; TMR2RLH holds the reload value for TMR2H. The TR2 bit in TMR2CN handles the run control for TMR2H. TMR2L is always running when configured for 8-bit Mode.

Each 8-bit timer may be configured to use SYSCLK, SYSCLK divided by 12, or the external oscillator clock source divided by 8. The Timer 2 Clock Select bits (T2MH and T2ML in CKCON) select either SYSCLK or the clock defined by the Timer 2 External Clock Select bit (T2XCLK in TMR2CN), as follows:

T2MH	T2XCLK	TMR2H Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

T2ML	T2XCLK	TMR2L Clock Source
0	0	SYSCLK / 12
0	1	External Clock / 8
1	X	SYSCLK

The TF2H bit is set when TMR2H overflows from 0xFF to 0x00; the TF2L bit is set when TMR2L overflows from 0xFF to 0x00. When Timer 2 interrupts are enabled, an interrupt is generated each time TMR2H overflows. If Timer 2 interrupts are enabled and TF2LEN (TMR2CN.5) is set, an interrupt is generated each time either TMR2L or TMR2H overflows. When TF2LEN is enabled, software must check the TF2H and TF2L flags to determine the source of the Timer 2 interrupt. The TF2H and TF2L interrupt flags are not cleared by hardware and must be manually cleared by software.

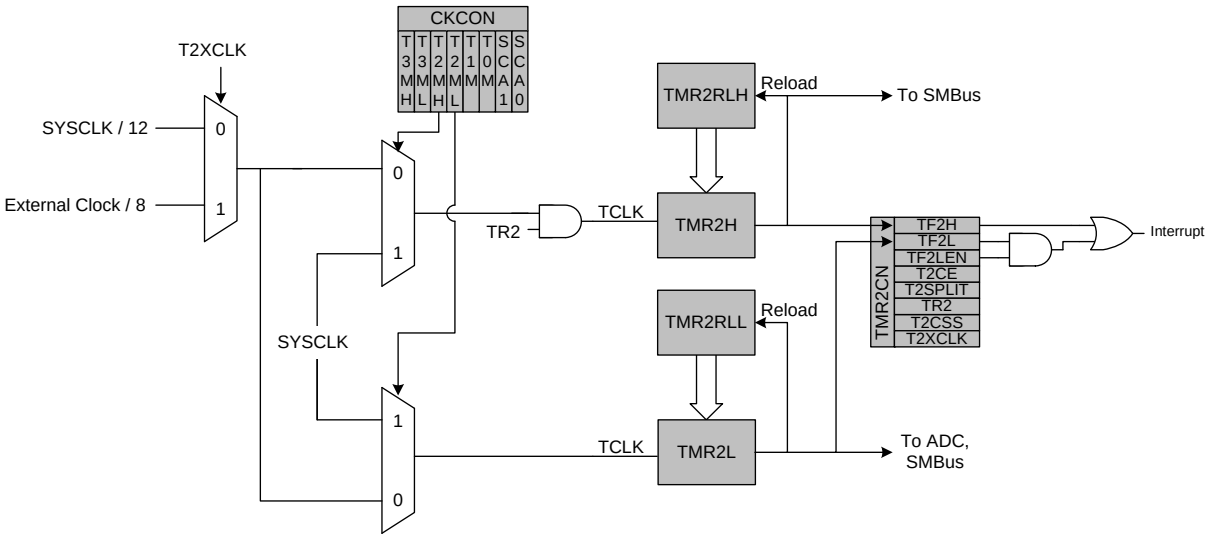

Figure 21.5. Timer 2 8-Bit Mode Block Diagram

SFR Definition 21.8. TMR2CN: Timer 2 Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
TF2H	TF2L	TF2LEN	T2CE	T2SPLIT	TR2	T2CSS	T2XCLK	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
							(bit addressable)	0xC8

Bit7: TF2H: Timer 2 High Byte Overflow Flag.
Set by hardware when the Timer 2 high byte overflows from 0xFF to 0x00. In 16 bit mode, this will occur when Timer 2 overflows from 0xFFFF to 0x0000. When the Timer 2 interrupt is enabled, setting this bit causes the CPU to vector to the Timer 2 interrupt service routine. TF2H is not automatically cleared by hardware and must be cleared by software.

Bit6: TF2L: Timer 2 Low Byte Overflow Flag.
Set by hardware when the Timer 2 low byte overflows from 0xFF to 0x00. When this bit is set, an interrupt will be generated if TF2LEN is set and Timer 2 interrupts are enabled. TF2L will set when the low byte overflows regardless of the Timer 2 mode. This bit is not automatically cleared by hardware.

Bit5: TF2LEN: Timer 2 Low Byte Interrupt Enable.
This bit enables/disables Timer 2 Low Byte interrupts. If TF2LEN is set and Timer 2 interrupts are enabled, an interrupt will be generated when the low byte of Timer 2 overflows.
0: Timer 2 Low Byte interrupts disabled.
1: Timer 2 Low Byte interrupts enabled.

Bit4: T2CE: Timer 2 Capture Enable
0: Capture function disabled.
1: Capture function enabled. The timer is in capture mode, with the capture event selected by bit T2CSS. Each time a capture event is received, the contents of the Timer 2 registers (TMR2H and TMR2L) are latched into the Timer 2 reload registers (TMR2RLH and TMR2RLH), and a Timer 2 interrupt is generated (if enabled).

Bit3: T2SPLIT: Timer 2 Split Mode Enable.
When this bit is set, Timer 2 operates as two 8-bit timers with auto-reload.
0: Timer 2 operates in 16-bit auto-reload mode.
1: Timer 2 operates as two 8-bit auto-reload timers.

Bit2: TR2: Timer 2 Run Control.
This bit enables/disables Timer 2. In 8-bit mode, this bit enables/disables TMR2H only; TMR2L is always enabled in this mode.
0: Timer 2 disabled.
1: Timer 2 enabled.

Bit1: T2CSS: Timer 2 Capture Source Select.
This bit selects the source of a capture event when bit T2CE is set to ‘1’.
0: Capture source is USB SOF event.
1: Capture source is falling edge of Low-Frequency Oscillator.

Bit0: T2XCLK: Timer 2 External Clock Select.
This bit selects the external clock source for Timer 2. If Timer 2 is in 8-bit mode, this bit selects the external oscillator clock source for both timer bytes. However, the Timer 2 Clock Select bits (T2MH and T2ML in register CKCON) may still be used to select between the external clock and the system clock for either timer.
0: Timer 2 external clock selection is the system clock divided by 12.
1: Timer 2 external clock selection is the external clock divided by 8. Note that the external oscillator source divided by 8 is synchronized with the system clock.

22.3. Watchdog Timer Mode

A programmable watchdog timer (WDT) function is available through the PCA Module 4. The WDT is used to generate a reset if the time between writes to the WDT update register (PCA0CPH4) exceed a specified limit. The WDT can be configured and enabled/disabled as needed by software.

With the WDTE and/or WDLCK bits set to '1' in the PCA0MD register, Module 4 operates as a watchdog timer (WDT). The Module 4 high byte is compared to the PCA counter high byte; the Module 4 low byte holds the offset to be used when WDT updates are performed. **The Watchdog Timer is enabled on reset. Writes to some PCA registers are restricted while the Watchdog Timer is enabled.**

22.3.1. Watchdog Timer Operation

While the WDT is enabled:

- PCA counter is forced on.
- Writes to PCA0L and PCA0H are not allowed.
- PCA clock source bits (CPS2-CPS0) are frozen.
- PCA Idle control bit (CIDL) is frozen.
- Module 4 is forced into Watchdog Timer mode.
- Writes to the Module 4 mode register (PCA0CPM4) are disabled.

While the WDT is enabled, writes to the CR bit will not change the PCA counter state; the counter will run until the WDT is disabled. The PCA counter run control (CR) will read zero if the WDT is enabled but user software has not enabled the PCA counter. If a match occurs between PCA0CPH4 and PCA0H while the WDT is enabled, a reset will be generated. To prevent a WDT reset, the WDT may be updated with a write of any value to PCA0CPH4. Upon a PCA0CPH4 write, PCA0H plus the offset held in PCA0CPL4 is loaded into PCA0CPH4 (See Figure 22.10).

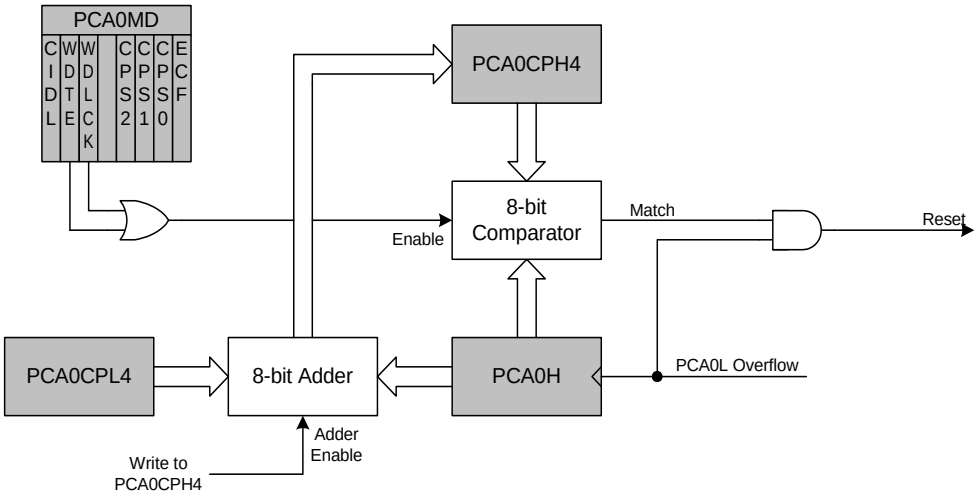

Figure 22.10. PCA Module 4 with Watchdog Timer Enabled

Note that the 8-bit offset held in PCA0CPH4 is compared to the upper byte of the 16-bit PCA counter. This offset value is the number of PCA0L overflows before a reset. Up to 256 PCA clocks may pass before the first PCA0L overflow occurs, depending on the value of the PCA0L when the update is performed. The total offset is then given (in PCA clocks) by Equation 22.4, where PCA0L is the value of the PCA0L register at the time of the update.